

TG-12F-KIT Specification

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Document development/revision/revocation resume

| Version | Date | Revised content | Edition | Approve |
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| V1.0 | 2020.11.26 | First Edition | Chen Cong | Xu Hong |
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— Product Overview

TG-12F-KIT development board is a multi-functional development board designed for TG-12F module, there are five routes PWM, all the modules are available IO to pin out use the pin header, convenient for developers to develop and debug;

TG-12F is 2.4G band, WiFi 802.11b/g/n and BLE5.0 baseband/ MAC design, built-in 276KB SRAM, 128KB ROM, provides a rich peripheral interface, including DSIO、SPI、I2C、IR remote、PWM、ADC、DAC、PIR and GPIO interfaces. Support AT command development and secondary development. Support Android / IOS APP control and Tmall genie control.

TG-12F the characteristics of high performance, low cost and agile development, it is suitable for all kinds of low power and high performance application development, such as electrical lighting, life appliances, home security, intelligent detection and other products.

Characteristics

Module Type: TG-12F; Interface type: standard micro USB+ 2.54mm pin header; Support SDIO/SPI/UART/I2C/IR remote/PWM/ADC/DAC/PIR/GPIO interfaces; Own R/G/B Sanhe one lamp bead and cold / warm lamp bead; Own reset button and a user-defined button; Support Tmall genie voice control directly; Support Android/IOS APP control; 802.11 b/g/n Wi-Fi BLE SoC module with data rate up to 150 Mbps; Ultra-low power: sleep power only 0.5 uA, network standby power only 40 uA (DTIM10); Common AT command can be easy and quickly used; support secondary development, integrated Linux development environment; Module uses open source autonomous controllable RISC-V CPU, adjustable for 1~160 MHz , 276 KB SRAM;



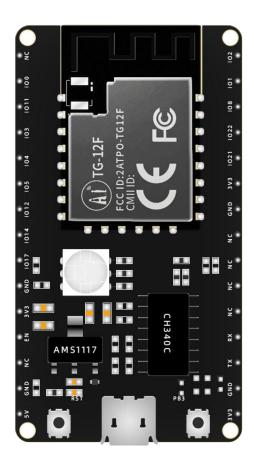
Main parameters

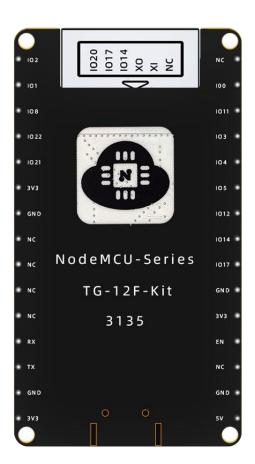
| Model name | TB-12F-Kit |
|--------------------------|---------------------------------------------------------------------------------|
| Package | DIP-30 (2.54 mm pin header) |
| Size | 48.0mm * 25.0mm * 14.0mm (±0.2mm) |
| Frequency range | 2400~2483.5MHz |
| Tx power | 20dBm |
| Receiving sensitivity | -97dBm |
| Interface | SDIO/SPI/UART/I2C/IR remote/PWM/ADC/DAC/PIR/GPIO |
| Operating temperature | -40 °C ~ 85 °C |
| Storage environment | -40 °C ~ 125 °C , < 90%RH |
| Power supply range | Micro USB power supply voltage 4.75V~5.25V, recommend 5.0V, power supply >500mA |
| ю | 14 |
| UART port rate | support 110 ~ 4608000 bps , default 115200 bps |
| Security | AES/SHA/PKA |
| SPI Flash | 2MB |
| Antenna | On-board PCB antenna /IPEX , default on-board PCB antenna |

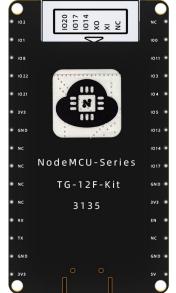
Table 1 main parameter descriptions



\Box , Appearance dimensions









TG-12F-KIT the development board moduleA,

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with 30 interfaces, refer to the pin diagram, pin function definition table is interface definition.

TB-04-KIT development board pin diagram

Pin Function Definition Table

| No. | Pin | Function |
|-----|------|-----------------------------------|
| 1 | NC | Empty Pin |
| 2 | 100 | SDIO,SFLASH,SPI,I2C,UART,PWM,GPIO |
| 3 | IO11 | SPI,I2C,UART,PWM,AUXADC,GPIO |
| 4 | IO3 | SDIO,SPI,I2C,UART,PWM,GPIO |
| 5 | IO4 | SDIO,SPI,I2C,UART,PWM,GPIO |
| 6 | 105 | SDIO,SPI,I2C,UART,PWM,GPIO |
| 7 | IO12 | SPI,I2C,UART,PWM,AUXADC,GPIO |
| 8 | IO14 | SPI,I2C,UART,PWM,AUXADC,GPIO |
| 9 | IO17 | SFLASH,SPI,I2C,UART,PWM,GPIO |
| 10 | GND | Ground |

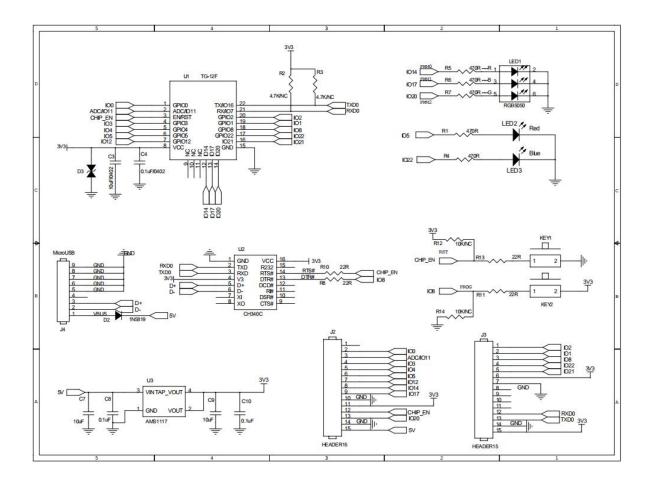
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| 11 | 3V3 | Power supply |
|----|------|----------------------------------------------|
| 12 | EN | Chip enable |
| 13 | NC | Empty Pin |
| 14 | GND | Ground |
| 15 | 5V | Power supply |
| 16 | 3V3 | Power supply |
| 17 | GND | Ground |
| 18 | ТХ | SPI,I2C,UART,PWM,GPIO |
| 19 | RX | SPI,I2C,UART,PWM,AUXADC,GPIO |
| 20 | NC | Empty pin |
| 21 | NC | Empty pin |
| 22 | NC | Empty pin |
| 23 | NC | Empty pin |
| 24 | GND | Ground |
| 25 | 3V3 | Power supply |
| 26 | IO21 | GPIO4, ADC2_CH0, TOUCH0, RTC_GPIO10, HSPIHD, |
| 27 | 1022 | SFLASH,SPI,I2C,UART,PWM,GPIO |
| 28 | 108 | SPI,I2C,UART,PWM,AUXADC,GPIO |
| 29 | IO1 | SDIO,SFLASH,SPI,I2C,UART,PWM,GPIO |
| 30 | 102 | SDIO,SFLASH,SPI,I2C,UART,PWM,GPIO |



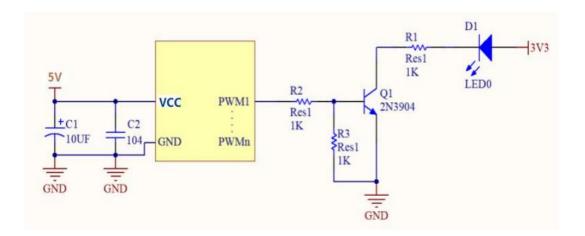
四、 Schematic diagram





$\underline{\pi}$ 、 Application guidance

1. Application circuit



2. Antenna layout requirements

Metal parts are forbidden to be placed around the antenna, away from high frequency devices.

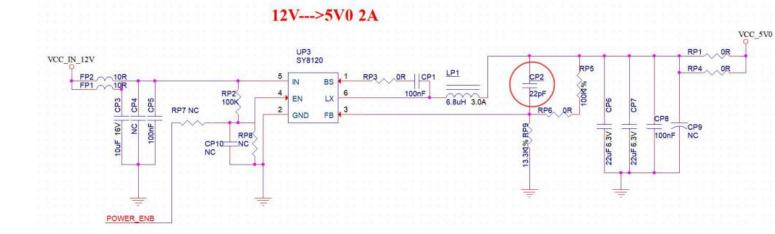
3、 Power supply

(1) , Recommend Micro USB 3.3V voltage, peak current above 50mA

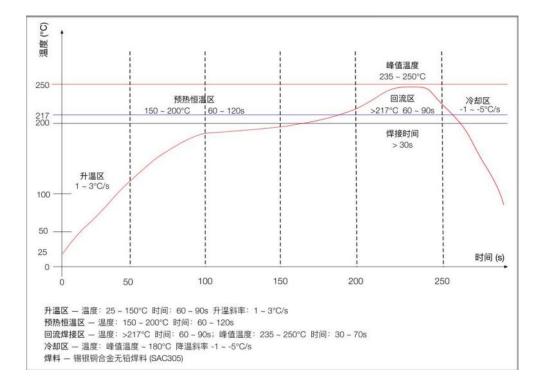
(2) $\$ It is recommended to use LDO for power supply; if DC-DC is used, the ripple is recommended to be controlled within 30mV.

(3) , DC-DC the power supply circuit, it is suggested to reserve the position of output ripple can be optimized when the load changes greatly.

(4) , It is recommended to add ESD devices to the 3.3V power interface.



六、Reflow soldering graphs





七、Package information

TG-12F-KIT development board is packaged with electrostatic bag

八、Contact us

Official website: <u>https://www.ai-thinker.com</u>

Development docs: <u>http://docs.ai-thinker.com</u>

Official forum: <u>http://bbs.ai-thinker.com</u>

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